

Dear Sirs

Date 1-Feb-16
 Issue No. KHS-15-2
 ROHM Semiconductor GmbH
 Discrete Product Marketing
 Akihiro Nishide

Product Change Information

ROHM would like to inform that we will have following change.
 This is for your information. Feedback is not required.

----- Note -----

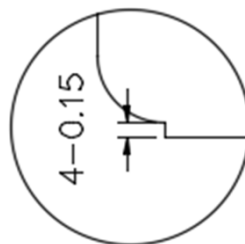
Application	Product Name	Part Number
	SiC Power module	BSM120D12P2C005, BSM180D12P2C101 BSM080D12P2C008, BSM180D12P3C007
Detailed description of change	Current Semi-gloss Ni plating/no Notch at corner	Subsequent Matte Ni plating /Notch at corner
Anticipated impact on quality	There are no impact on fit, function, reliability and Electrical characteristics	
Purpose of Change	For stabilizing supply and quality by shifting to an experienced raw material supplier	
Time of change	running change (Plan: from Jul/2016)	
Qualification samples	from Feb/2016	

【Overview of the Change】

	Current	Subsequent
Plating type	Semi-gloss Ni plating	Matte Ni plating
Plating thickness	5±2	
Base material	Cu; C1020	
Shape	No notch at corner	Notch at corner
Other	no change on characteristic and reliability	

current

subsequent



1. There will be a notch.
2. The surface of subsequent product is unglassy and whity.